2SB709, 2SB709A

Silicon PNP Epitaxial Planar Type

For general amplification Complementary pair with 2SD601 and 2SD601A

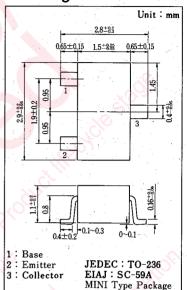
■ Features

- •High DC current gain her
- •As it is a MINI type package, downsizing of equipment and automatic insertion by taping and magazine packaging are possible.

■ Absolute Maximum Ratings (Ta=25°C)

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Item		Symbol Value		Unit	
Collector-Base	2SB709	W.	-25	W	
Voltage	2SB709A	V _{CBO}	-45	v V	
Collector-Emitter	2SB709	V _{CEO}	-25	37	
Voltage	2SB709A	V CEO	-45	v .	
Emitter-Base Voltage		V_{EBO}	-7	V	
Peak Collector Voltage		I _{CP}	-200	mA	
Collector Current		I _c	-100	mA	
Collector Power Dissipation		P _c	200	mW	
Junction Temperature		Ti	150) (C)	
Storage Temperature		T_{stg}	$-55 \sim +150$	il c	
				277 F 733	

■ Package Dimensions



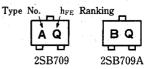
■ Electrical Characteristics (Ta=25°C)

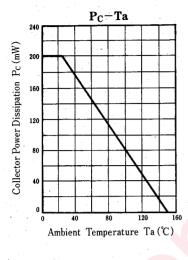
Iter	n	Symbol	Condition	min.	typ.	max.	Unit
Collector Cutoff Current		I _{сво}	$V_{CB} = -20 \text{ V}, I_E = 0$	0	(O)	-0.1	μA
		I _{CEO}	$V_{CE} = -10 \text{ V}, I_{B} = 0$			-100	
Collector-Base	2SB709	V _{CBO}	$I_{\rm C} = -10 \ \mu A, \ I_{\rm E} = 0$	-25			v
Voltage	2SB709A	у сво	$_{1C} = -10 \mu A, _{1E} = 0$	-45			
Collector-Emitter	2SB709	V_{ceo}	$I_{C} = -2 \text{ mA}, I_{B} = 0$	-25			v
Voltage 2	2SB709A	V CEO	$I_C = -2 \text{ mA}, I_B = 0$	-45			v
Emitter-Base Volta	ge O	V _{EBO}	$I_{\rm E} = -10 \ \mu A, \ I_{\rm C} = 0$	-7			V
DC Current Gain	<u>()</u>	h _{FE} *	$V_{CE} = -10 \text{ V}, I_{C} = -2 \text{ mA}$	160		460	
Collector-Emitter Satu	uration Voltage	V _{CE(sat)}	$I_C = -100 \text{ mA}, I_B = -10 \text{ mA}$		-0.3	-0.5	v
Transition Frequency		f _T	$V_{CB} = -10 \text{ V}, I_E = 1 \text{ mA}, f = 200 \text{MHz}$		80	1	MHz
Collector Output Capacitance		Соь	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		2.7		pF

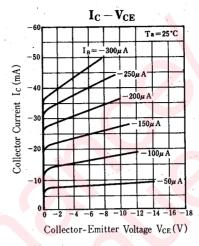
* hre Ranking

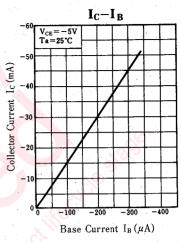
Rank h _{FE}		Q	R	S 290~460	
		160~260	210~340		
Marking	2SB709	AQ	AR	AS	
	2SB709A	BQ	BR	BS	

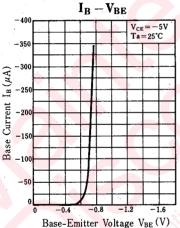
■ Type Name Marking (Example)

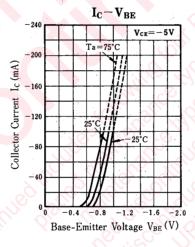


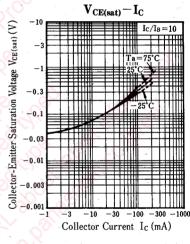


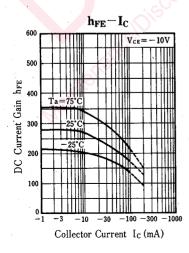


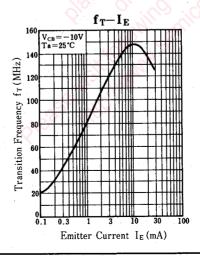


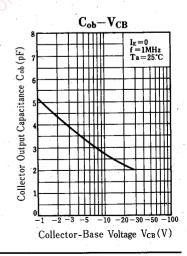


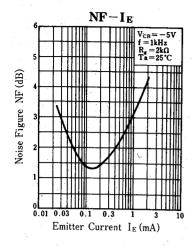


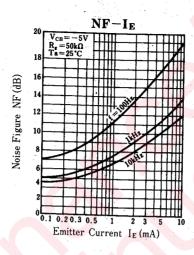


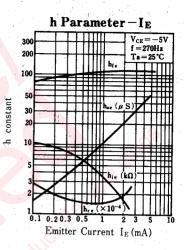


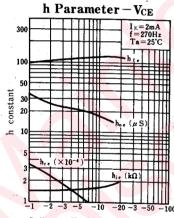












Collector-Emitter Voltage VCE(V)

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